

**Amendments to the Claims:**

1. (Original) A memory card comprising:  
a leadframe having a plurality of contacts;  
at least one semiconductor die electrically connected to the leadframe; and  
a body at least partially encapsulating the leadframe and including:  
opposed top and bottom surfaces;  
an opposed pair of longitudinal sides; and  
an opposed pair of lateral sides;  
the contacts of the leadframe being exposed in the bottom surface of the body  
and extending to one of the lateral sides thereof.
2. (Original) The memory card of Claim 1 wherein:  
the bottom surface of the body is generally planar; and  
each of the contacts defines a generally planar bottom surface which is  
substantially flush with the bottom surface of the body.
3. (Original) The memory card of Claim 1 wherein the body further includes a  
sloped side which extends between one of the lateral sides and one of the longitudinal sides  
thereof, the contacts extending to the lateral side which extends to the sloped side.
4. (Original) The memory card of Claim 1 wherein the leadframe includes seven  
contacts.
5. (Withdrawn) The memory card of Claim 1 wherein the leadframe further  
includes a pair of dummy pads which are exposed in the bottom surface of the body and  
extend to the lateral side thereof to which the contacts extend.
6. (Withdrawn) The memory card of Claim 5 wherein the leadframe includes  
seven contacts.
7. (Withdrawn) The memory card of Claim 6 wherein:  
the body further includes a sloped side which extends between one of the  
longitudinal sides and one of the lateral sides thereof;  
the contacts extend to the lateral side of the body which extends to the sloped  
side; and

one of the dummy pads extends to the sloped side, with the remaining one of the dummy pads extending to the lateral side to which the contacts extend.

8. (Withdrawn) The memory card of Claim 7 wherein:

the bottom surface of the body is generally planar; and

each of the contacts and each of the dummy pads defines a generally planar bottom surface which is substantially flush with the bottom surface of the body.

9. (Currently Amended) A memory card **for insertion into a host socket having connector pins, the memory card** comprising:

a leadframe having a plurality of contacts;

at least one semiconductor die electrically connected to the leadframe; and

a body at least partially encapsulating the leadframe and including:

opposed top and bottom surfaces;

~~an opposed~~ **a first** pair of longitudinal **opposed** sides; and

~~an opposed~~ **a second** pair of lateral opposed sides;

the contacts of the leadframe being exposed in the bottom surface of the body and ~~extending to a notch formed in the body and extending along one of the lateral sides thereof~~ **being oriented relative thereto such that the connector pins of the host socket do not travel over the body prior to engaging the contacts when the memory card is advanced into the host socket.**

10. (Original) The memory card of Claim 9 wherein:

the bottom surface of the body is generally planar; and

each of the contacts defines a generally planar bottom surface which is substantially flush with the bottom surface of the body.

11. (Currently Amended) The memory card of Claim 9 wherein the body further includes a sloped side which extends between one of the lateral sides **of the first pair** and one of the longitudinal sides **of the second pair** thereof, ~~the notch extending along the lateral side which extends to the sloped side and along at least a portion of the sloped side.~~

12. (Original) The memory card of Claim 9 wherein the leadframe includes seven contacts.

13. (Withdrawn) The memory card of Claim 9 wherein the leadframe further includes a pair of dummy pads which are exposed in the bottom surface of the body and ~~extend to the notch~~ **are oriented relative thereto such that the connector pins of the host socket do not travel over the body prior to engaging the dummy pads when the memory card is advanced into the host socket.**

14. (Withdrawn) The memory card of Claim 13 wherein the leadframe includes seven contacts.

15. (Withdrawn) The ~~leadframe~~ **memory card** of Claim 14 wherein:

the body further includes a sloped side which extends between one of the longitudinal sides **of the first pair** and one of the lateral sides **of the second pair** thereof, ~~the notch extending along at least a portion of the sloped side and along the lateral side which extends to the sloped side; and~~

~~one of the dummy pads extends to a portion of the notch extending along the sloped side, with the remaining one of the dummy pads extending to a portion of the notch which extends along one of the lateral sides.~~

16. (Withdrawn) The memory card of Claim 9 wherein the **contacts extend to a notch which** is ~~partially defined by a shoulder which is perpendicularly recessed relative to the bottom surface of~~ **formed in** the body.

17. (Currently Amended) A method of fabricating a memory card, comprising the steps of:

- a) providing a leadframe having a plurality of contacts;
- b) electrically connecting at least one semiconductor die to the leadframe;

**and**

c) partially encapsulating the leadframe and the semiconductor die with a body which includes opposed top and bottom surfaces, an opposed pair of longitudinal sides, and an opposed pair of lateral sides **such that the contacts are exposed in the bottom surface of the body and extend to one of the lateral sides thereof**; ~~and~~

~~d) ablating a portion of the body in a manner facilitating the formation of a notch which extends between the contacts and one of the lateral sides of the body.~~

18. (Cancelled)

19. (Currently Amended) The method of Claim 17 wherein:

step (c) comprises forming the body to include a sloped side which extends between one of the lateral sides and one of the longitudinal sides thereof; ~~and~~

~~step (d) comprises ablating the body such that the notch extends along at least a portion of the sloped side and along the lateral side which extends to the sloped side.~~

20. (Withdrawn) The method of Claim ~~18~~ 17 wherein:

step (a) comprises providing a leadframe which further includes a pair of dummy pads; **and**

step (c) comprises forming the body such that the dummy pads are exposed in the bottom surface thereof; ~~and~~

~~step (d) comprises ablating the body such that each of the dummy pads and each of the contacts extends to the notch formed in the body.~~

**21. (New/Withdrawn) The memory card of Claim 16 wherein the notch is partially defined by a shoulder which is perpendicularly recessed relative to the bottom surface of the body.**